These assemblies are ESD sensitive, ESD precautions shall be observed.
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Component marked 'DNP' should not be populated, and may not be in bill of materials Assembly variant: 001

PCB VIEWED FROM TOP SIDE

IGNORE -> Top Overlay

PLOT NAME = Top Assembly Drawing

BOARD #: PMP9561
REV: E1
SUN REV: Not In VersionControl

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